Supplier Na	ime:
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Created on	:

Texas Instruments Inc. (DUNS# 00-732-1904) ti.com/support Distribute - RoHS and IEC 62474 DB

06/07/2022

Details for "TCA1116PWR"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
TCA1116PWR	NIPDAU	Level-1-260C-UNLIM	TI MALAYSIA A/T	PW 24	7.7x4.4x1.0	89.3

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

	Substance			Homogeneous Material Level		Component Level	
Component		CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.131755	99.997723	999977	0.147461	1475
Copper and Its Alloys	Iron	7439-89-6	0.000001	0.000759	8	0.000001	. 0
Precious Metals	Silver	7440-22-4	0.000002	0.001518	15	0.000002	0
Sub-Total			0.131758	100	1000000	0.147465	1475
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.15883	80.000201	800002	0.177764	1778
Thermoplastics	Epoxy	85954-11-6	0.039707	19.999799	199998	0.04444	444
Sub-Total			0.198537	100	1000000	0.222204	2222
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	34.28832	97.41	974100	38.375791	383758
Copper and Its Alloys	Iron	7439-89-6	0.8448	2.4	24000	0.945508	9455
Copper and Its Alloys	Phosphorus	7723-14-0	0.01056	0.03	300	0.011819	118
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.01056	0.03	300	0.011819	118
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.01056	0.03	300	0.011819	118
Zinc and Its Alloys	Zinc	7440-66-6	0.0352	0.1	1000	0.039396	394
Sub-Total			35.2	100	1000000	39.396151	393962
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.608768	95.12	951200	0.681339	6813
Precious Metals	Gold	7440-57-5	0.004992	0.78	7800	0.005587	56
Precious Metals	Palladium	7440-05-3	0.02624	4.1	41000	0.029368	294
Sub-Total			0.64	100	1000000	0.716294	7163
Mold Compound	-	•		•	-	•	
Other Inorganic Materials	Fused Silica	60676-86-0	45.174726	86	860000	50.559952	505600
Other Plastics and Rubber	Carbon Black	1333-86-4	0.157586	0.3	3000	0.176372	1764
Thermoplastics	Ероху	85954-11-6	7.196439	13.7	137000	8.054318	80543
Sub-Total			52.528751	100	1000000	58.790642	587906
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	0.649784	100	1000000	0.727244	7272
Sub-Total			0.649784	100	1000000	0.727244	7272
Total			89.34883			100	1000000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component. The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**. See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

Ti bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/07/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.